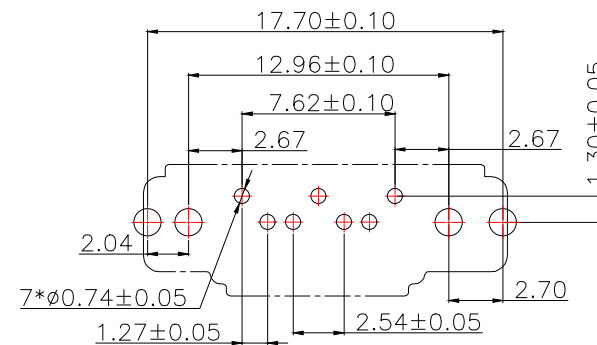
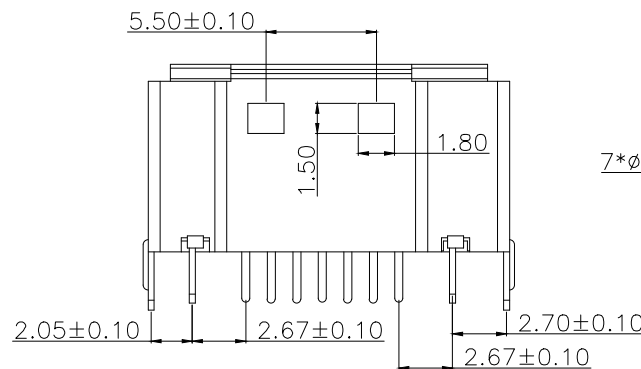
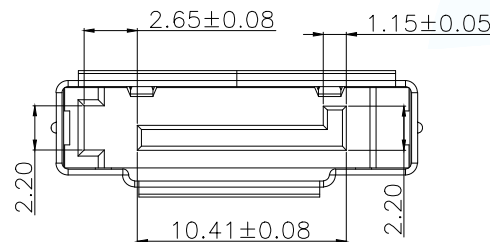
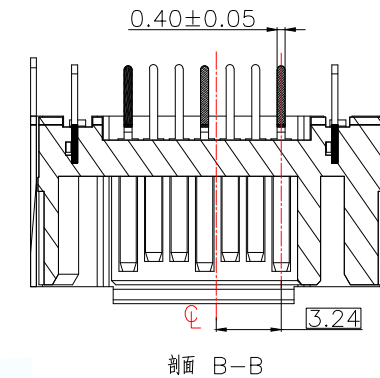
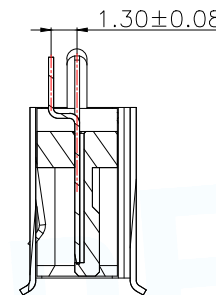
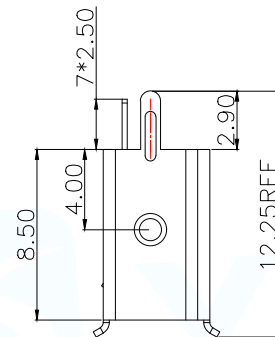
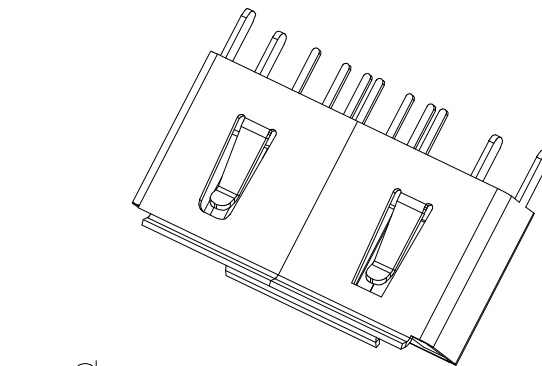
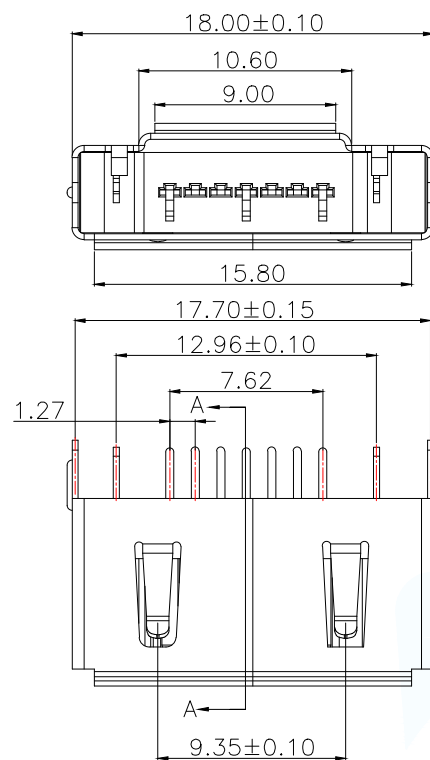




PCB LAYOUT

SPECIFICATION:

MATERIAL:

HOUSING: LCP 30% G/F UL 94V-0

COLOR:BLACK

CONTACT: PHOSPHOR BRONZE C2680 H,T=0.25mm

PEG: BRASS C2680R H,T=0.30mm

SHELL: spcc,T=0.30mm

FINISH:

CONTACT: G/F GOLD/TIN PLATING ON CONTACT AREA

100u" MIN. Matte TIN PLATING ON SOLDER TAILS

50u" MIN. NICKEL UNDERPLATING OVERALL

PEG:100u" MIN. Matte TIN PLATING ON SOLDER TAILS

50u" MIN. NICKEL UNDERPLATING OVERALL

SHELL:100u" MIN. Matte TIN PLATING ON SOLDER TAILS

50u" MIN. NICKEL UNDERPLATING OVERALL

MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:SATA 7P公座双柱AB型 带铁壳成品
DECIMALS:	ANGLES:		PAR SATA-04G-7AZZ-Z25
.X:±0.30	.X':±3°		DWN Lucas
.XX:±0.20	.XX':±2°		CHKD Ethan
.XXX:±0.05	.XXX':±0.5°		APVD Jacob
CUSTOMER COPY		SCALE:1:1	UNIT:MM
		SIZE:A4	SHEET:1F1
			REV:A